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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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MOS FIELD EFFECT TRANSISTOR NP50P04KDG

SWITCHING P-CHANNEL POWER MOSFET

DESCRIPTION

The NP50P04KDG is P-channel MOS Field Effect Transistor designed for high current switching applications.

<R> ORDERING INFORMATION

| PART NUMBER | LEAD PLATING | PACKING | PACKAGE |
|----------------------------------|---------------|-----------------|------------------|
| NP50P04KDG-E1-AY ^{Note} | Pure Sn (Tin) | Tape 800 p/reel | TO-263 (MP-25ZK) |
| NP50P04KDG-E2-AY ^{Note} | | | |

Note Pb-free (This product does not contain Pb in external electrode.)

FEATURES

- Super low on-state resistance

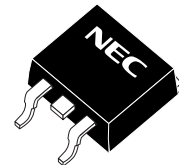
$R_{DS(on)1} = 10 \text{ m}\Omega \text{ MAX. (} V_{GS} = -10 \text{ V, } I_D = -25 \text{ A)}$

$R_{DS(on)2} = 15 \text{ m}\Omega \text{ MAX. (} V_{GS} = -4.5 \text{ V, } I_D = -25 \text{ A)}$

- Low input capacitance

$C_{iss} = 5100 \text{ pF TYP.}$

(TO-263)



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

| | | | |
|---|-----------------------|-------------|----|
| Drain to Source Voltage (V _{GS} = 0 V) | V _{DSS} | -40 | V |
| Gate to Source Voltage (V _{DS} = 0 V) | V _{GSS} | ±20 | V |
| Drain Current (DC) (T _c = 25°C) | I _{D(DC)} | ±50 | A |
| Drain Current (pulse) ^{Note1} | I _{D(pulse)} | ±150 | A |
| Total Power Dissipation (T _c = 25°C) | P _{T1} | 90 | W |
| Total Power Dissipation (T _A = 25°C) | P _{T2} | 1.8 | W |
| Channel Temperature | T _{ch} | 175 | °C |
| Storage Temperature | T _{stg} | -55 to +175 | °C |
| Single Avalanche Current ^{Note2} | I _{AS} | 37 | A |
| Single Avalanche Energy ^{Note2} | E _{AS} | 136 | mJ |

Notes 1. PW ≤ 10 μs, Duty Cycle ≤ 1%

2. Starting T_{ch} = 25°C, V_{DD} = -30 V, R_G = 25 Ω, V_{GS} = -20 → 0 V

THERMAL RESISTANCE

| | | | |
|---------------------------------------|-----------------------|------|------|
| Channel to Case Thermal Resistance | R _{th(ch-C)} | 1.67 | °C/W |
| Channel to Ambient Thermal Resistance | R _{th(ch-A)} | 83.3 | °C/W |

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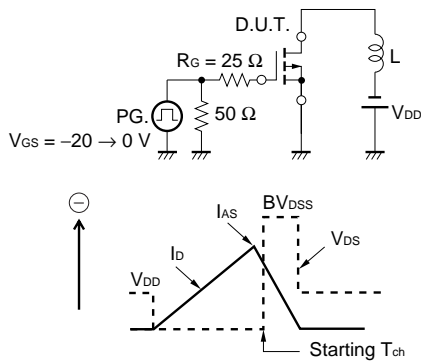
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ELECTRICAL CHARACTERISTICS (T_A = 25°C)

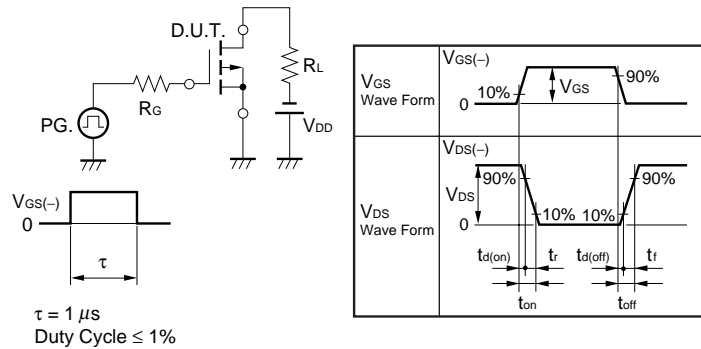
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|----------------------|--|------|------|------|------|
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = -40 V, V _{GS} = 0 V | | | -10 | μA |
| Gate Leakage Current | I _{GSS} | V _{GS} = ±20 V, V _{DS} = 0 V | | | ±100 | nA |
| Gate to Source Threshold Voltage | V _{GS(th)} | V _{DS} = -10 V, I _D = -1 mA | -1.0 | -1.6 | -2.5 | V |
| Forward Transfer Admittance ^{Note} | y _{fs} | V _{DS} = -10 V, I _D = -25 A | 15 | 30 | | S |
| Drain to Source On-state Resistance ^{Note} | R _{DS(on)1} | V _{GS} = -10 V, I _D = -25 A | | 7.9 | 10 | mΩ |
| | R _{DS(on)2} | V _{GS} = -4.5 V, I _D = -25 A | | 9.8 | 15 | mΩ |
| Input Capacitance | C _{iss} | V _{DS} = -10 V, | | 5100 | | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, | | 790 | | pF |
| Reverse Transfer Capacitance | C _{rss} | f = 1 MHz | | 440 | | pF |
| Turn-on Delay Time | t _{d(on)} | V _{DD} = -20 V, I _D = -25 A, | | 20 | | ns |
| Rise Time | t _r | V _{GS} = -10 V, | | 45 | | ns |
| Turn-off Delay Time | t _{d(off)} | R _G = 0 Ω | | 405 | | ns |
| Fall Time | t _f | | | 230 | | ns |
| Total Gate Charge | Q _G | V _{DD} = -32 V, | | 100 | | nC |
| Gate to Source Charge | Q _{GS} | V _{GS} = -10 V, | | 13 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = -50 A | | 42 | | nC |
| Body Diode Forward Voltage ^{Note} | V _{F(S-D)} | I _F = -50 A, V _{GS} = 0 V | | 0.95 | 1.5 | V |
| Reverse Recovery Time | t _{rr} | I _F = -50 A, V _{GS} = 0 V, | | 48 | | ns |
| Reverse Recovery Charge | Q _{rr} | di/dt = -100 A/μs | | 66 | | nC |

Note Pulsed test PW ≤ 350 μs, Duty Cycle ≤ 2%

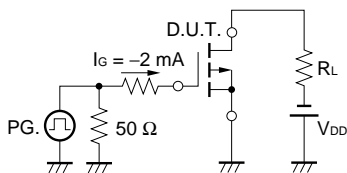
TEST CIRCUIT 1 AVALANCHE CAPABILITY



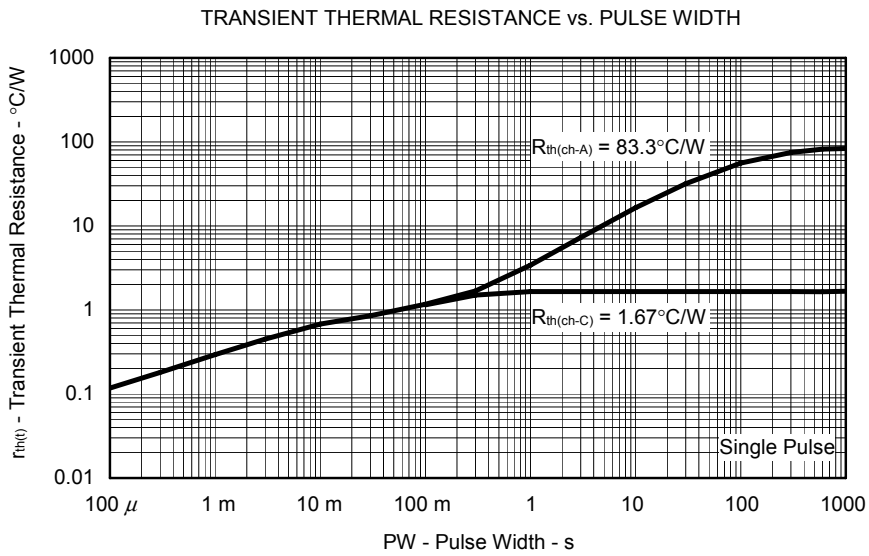
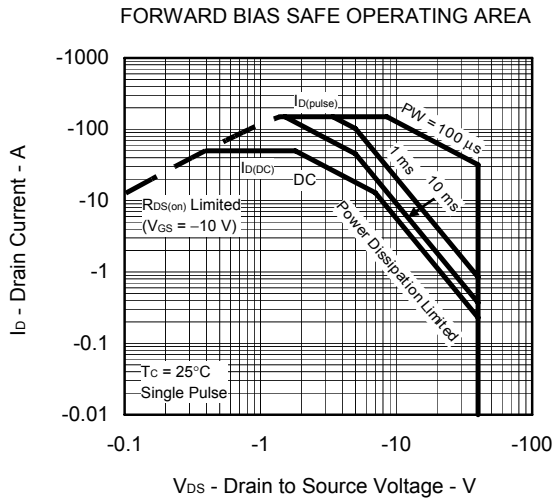
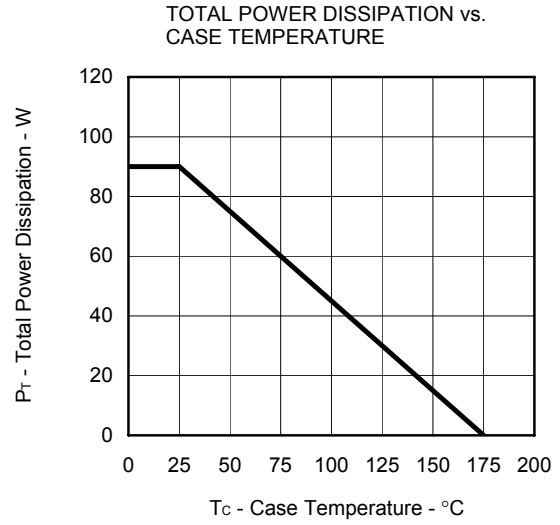
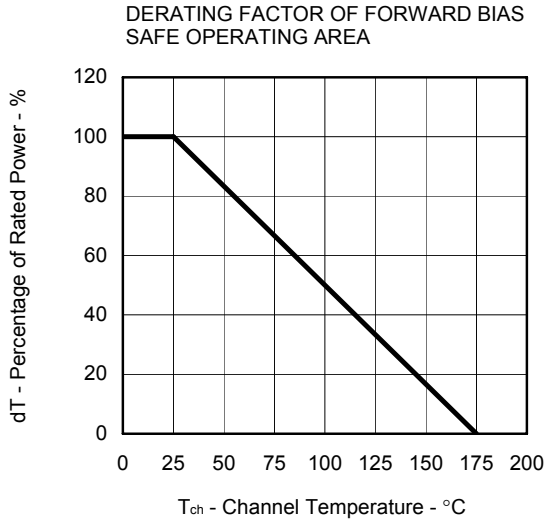
TEST CIRCUIT 2 SWITCHING TIME



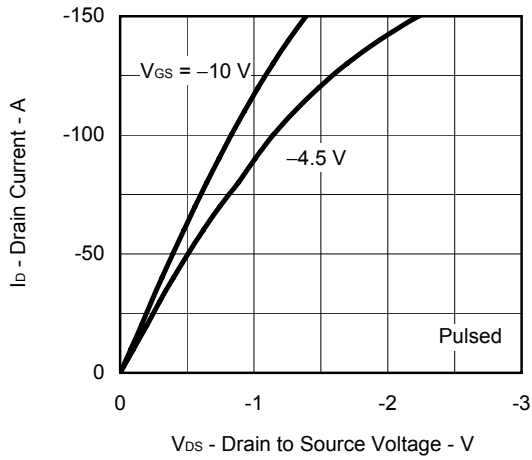
TEST CIRCUIT 3 GATE CHARGE



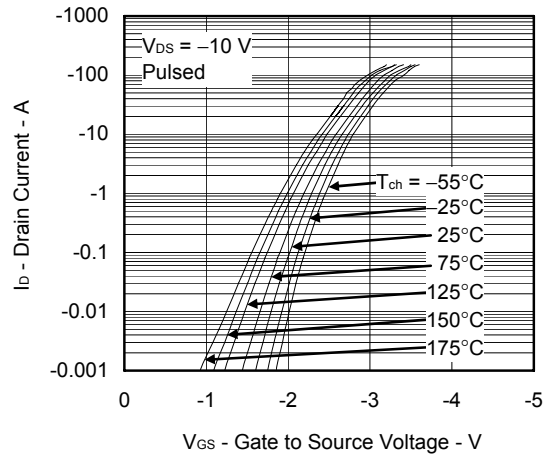
TYPICAL CHARACTERISTICS (T_A = 25°C)



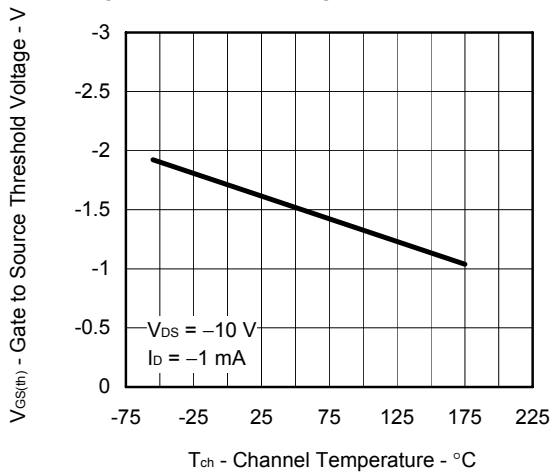
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



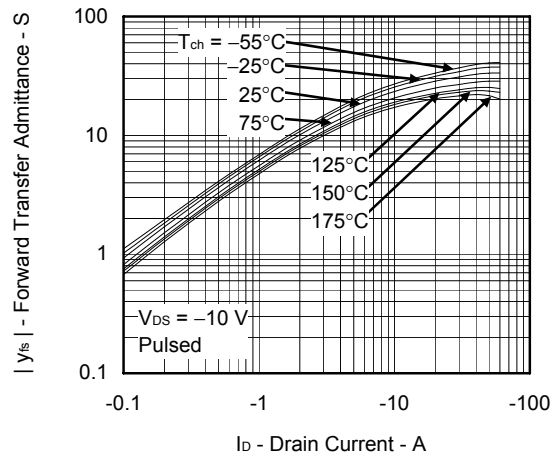
FORWARD TRANSFER CHARACTERISTICS



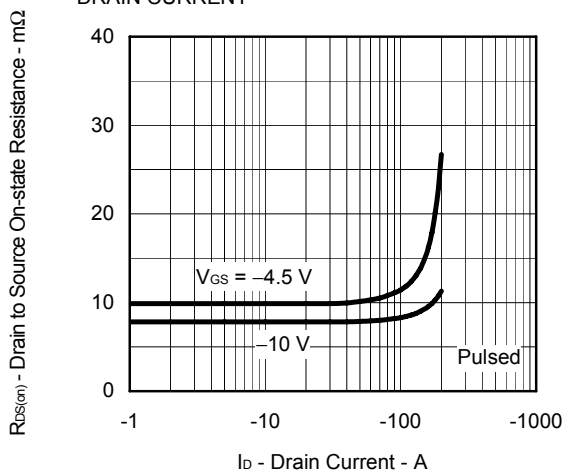
GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



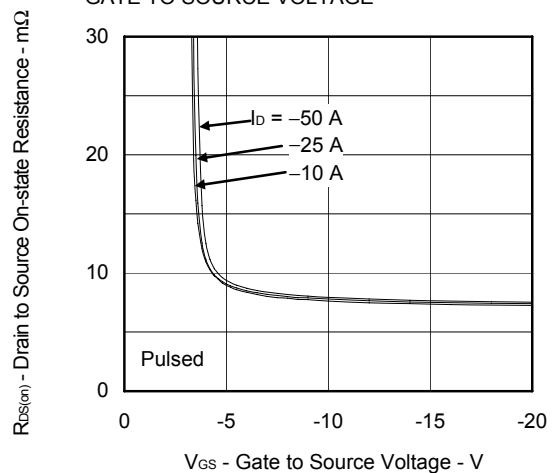
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

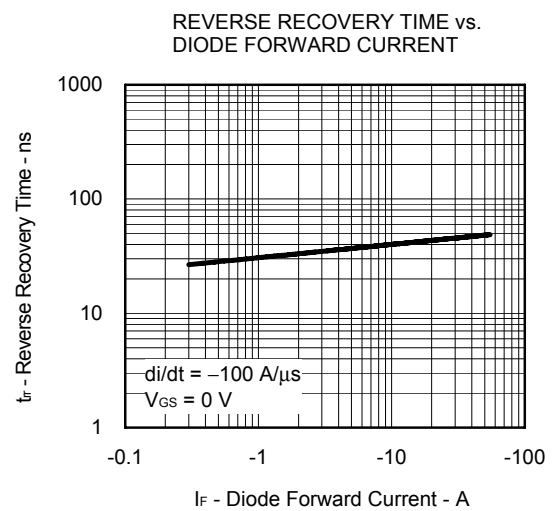
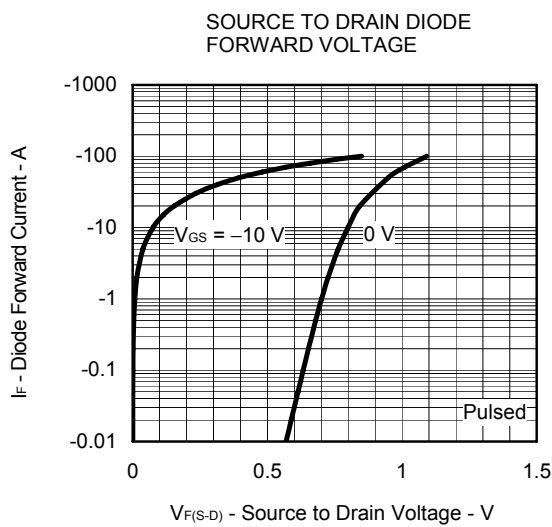
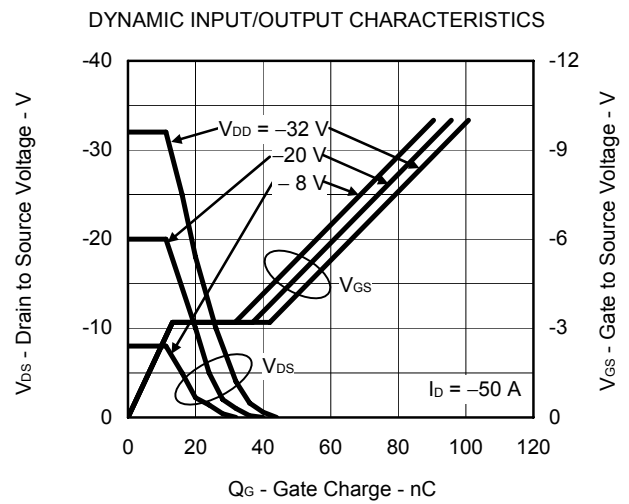
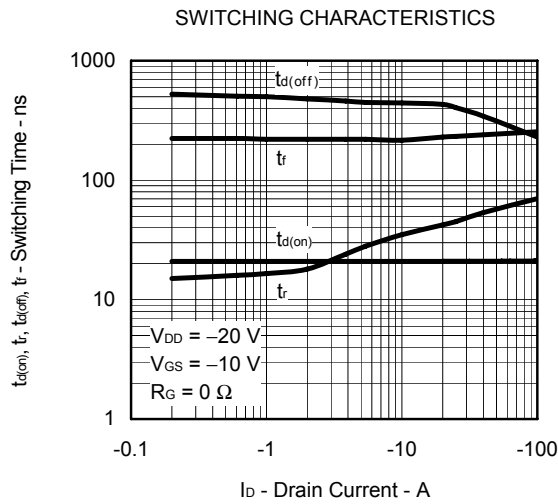
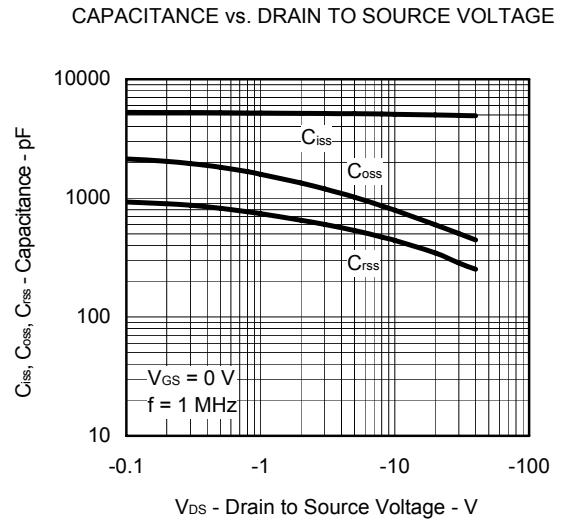
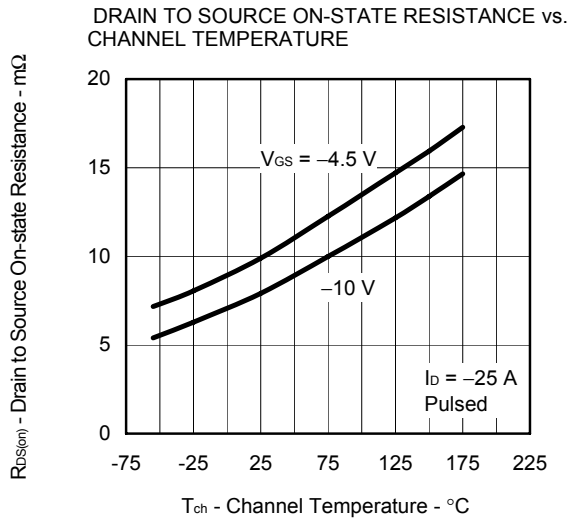


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



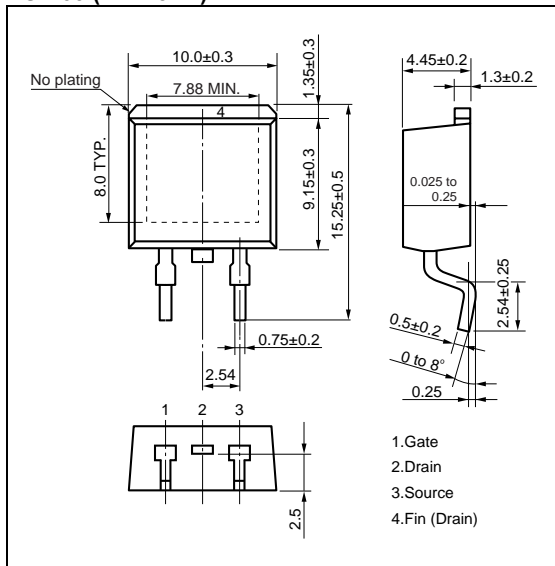
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



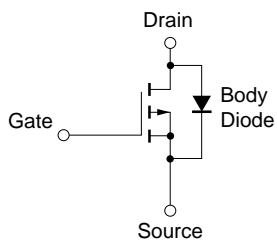


PACKAGE DRAWING (Unit: mm)

TO-263 (MP-25ZK)



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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